## **STARPOWER**

SEMICONDUCTOR™

**IGBT** 

## GD75HFK60C1S

**Molding Type Module** 

600V/75A 2 in one-package

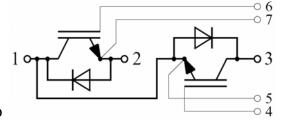
### **General Description**

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general UPS and SMPS.



#### **Features**

- Low V<sub>CE(sat)</sub> NPT IGBT technology
- 10µs short circuit capability
- V<sub>CE(sat)</sub> with positive temperature coefficient
- Rugged with ultrafast performance
- Square RBSOA
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



**Equivalent Circuit Schematic** 

### **Typical Applications**

- Electrical welder
- SMPS
- UPS

## Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

Symbol	Description	GD75HFK60C1S	Units
$V_{CES}$	Collector-Emitter Voltage	600	V
$V_{GES}$	Gate-Emitter Voltage	±20	V
ī	Collector Current @ T <sub>C</sub> =25 °C	110	A
$I_{C}$	@ T <sub>C</sub> =80℃	75	A
I <sub>CM(1)</sub>	Pulsed Collector Current t <sub>p</sub> =1ms	150	A
$I_{\mathrm{F}}$	Diode Continuous Forward Current	75	A
$I_{FM}$	Diode Maximum Forward Current	150	A
$P_{\mathrm{D}}$	Maximum Power Dissipation @ T <sub>j</sub> =150℃	297	W
$T_{SC}$	Short Circuit Withstand Time @ T <sub>j</sub> =125°C	10	μs
$T_{j}$	Maximum Junction Temperature	150	$^{\circ}$
$T_{STG}$	Storage Temperature Range	-40 to +125	${\mathbb C}$
$V_{\rm ISO}$	Isolation Voltage RMS,f=50Hz,t=1min	2500	V
Mounting Torque	Power Terminal Screw:M5	2.5 to 5.0	N.m
	Mounting Screw:M6	3.0 to 5.0	N.m

#### **Notes:**

### **Electrical Characteristics of IGBT** $T_C$ =25 $^{\circ}$ C unless otherwise noted

### **Off Characteristics**

Symbol	Parameter	<b>Test Conditions</b>	Min.	Typ.	Max.	Units
V <sub>(BR)CES</sub>	Collector-Emitter	T-25°C	600			N/
	Breakdown Voltage	T <sub>j</sub> =25℃				v
I <sub>CES</sub>	Collector Cut-Off Current	$V_{\text{CE}}=V_{\text{CES}}, V_{\text{GE}}=0V,$			1.0	A
		T <sub>j</sub> =25℃				mA
$I_{GES}$	Gate-Emitter Leakage	$V_{GE}=V_{GES}, V_{CE}=0V,$			400	nA
	Current	T <sub>j</sub> =25℃			400	

### **On Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{\text{GE(th)}}$	Gate-Emitter Threshold	$I_{C}=250\mu A, V_{CE}=V_{GE},$	2.5	4.5	5.5	V
	Voltage	$I_C=250\mu A, V_{CE}=V_{GE},$ $T_j=25$ °C	3.5			
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_{C}$ =75A, $V_{GE}$ =15V,		1.95	2.40	V
		$I_{C}=75A, V_{GE}=15V,$ $T_{j}=25 ^{\circ}C$				
		$I_{C}$ =75A, $V_{GE}$ =15V,		2.25		V
		$I_{C}=75A, V_{GE}=15V,$ $T_{j}=125^{\circ}C$				

<sup>(1)</sup> Repetitive rating: Pulse width limited by max. junction temperature

### **Switching Characteristics**

Symbol	Parameter	<b>Test Conditions</b>	Min.	Тур.	Max.	Units
t <sub>d(on)</sub>	Turn-On Delay Time			217		ns
$t_{\rm r}$	Rise Time			72		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V -200VI -75A		230		ns
$t_{\mathrm{f}}$	Fall Time	$V_{CC}=300V,I_{C}=75A,$ $R_{G}=18\Omega,V_{GE}=\pm15V,$		88		ns
Eon	Turn-On Switching Loss	$T_{j}=25^{\circ}C$		1.69		mJ
$E_{\text{off}}$	Turn-Off Switching Loss			1.33		mJ
$t_{d(on)}$	Turn-On Delay Time			213		ns
$t_r$	Rise Time			72		ns
$t_{d(off)}$	Turn-Off Delay Time	V -200VI -75A		236		ns
$t_{\mathrm{f}}$	Fall Time	$V_{CC}=300V,I_{C}=75A,$ $R_{G}=18\Omega,V_{GE}=\pm15V,$ $T_{j}=125^{\circ}C$		103		ns
Eon	Turn-On Switching Loss			1.79		mJ
E <sub>off</sub>	Turn-Off Switching Loss			1.80		mJ
Cies	Input Capacitance			4.30		nF
Coes	Output Capacitance	$V_{CE}$ =30V,f=1MHz, $V_{GE}$ =0V		0.35		nF
$C_{res}$	Reverse Transfer Capacitance			0.16		nF
$I_{SC}$	SC Data	$t_{SC} \le 10 \mu s, V_{GE} = 15 V,$ $T_{j} = 125 ^{\circ}C, V_{CC} = 360 V,$ $V_{CEM} \le 600 V$		TBD		A
L <sub>CE</sub>	Stray Inductance				30	nН
R <sub>CC'+EE'</sub>	Module Lead Resistance, Terminal to Chip	T <sub>C</sub> =25°C		0.75		mΩ

## **Electrical Characteristics of DIODE** T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
$V_{\mathrm{F}}$	Diode Forward	I -75 A	T <sub>j</sub> =25℃		1.50	1.90	V
	Voltage	$I_F=75A$	T <sub>j</sub> =125℃		1.55		]
Qr	Dagayarad Charga		T <sub>j</sub> =25℃		3.2		C
	Recovered Charge	$I_F=75A$ ,	T <sub>j</sub> =125℃		4.2		μС
ī	Peak Reverse	$V_R = 300V$ ,	T <sub>j</sub> =25℃		49		
$I_{RM}$	Recovery Current	di/dt=-1200A/μs,	T <sub>j</sub> =125℃		51		A
E <sub>rec</sub>	Reverse Recovery	$V_{GE}=-15V$	T <sub>j</sub> =25℃		0.76		mJ
	Energy		T <sub>j</sub> =125℃		0.96		1113

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (per IGBT)		0.42	K/W
$R_{\theta JC}$	Junction-to-Case (per DIODE)		1.04	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.05		K/W
Weight	Weight of Module	150		g

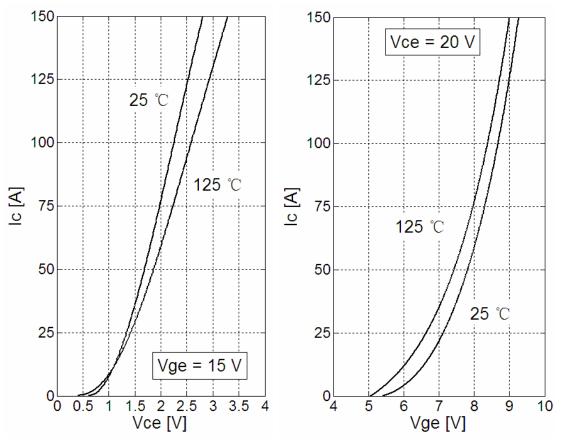


Fig 1. IGBT Typical Output Characteristics Fig 2. IGBT Typical Transfer Characteristics

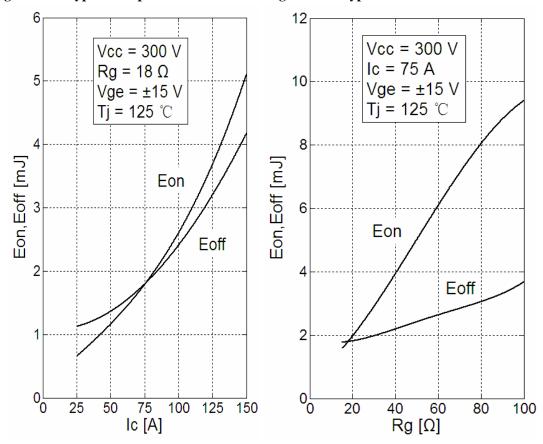


Fig 3. IGBT Switching Loss vs. I<sub>C</sub>

Fig 4. IGBT Switching Loss vs.  $R_{\rm G}\,$ 

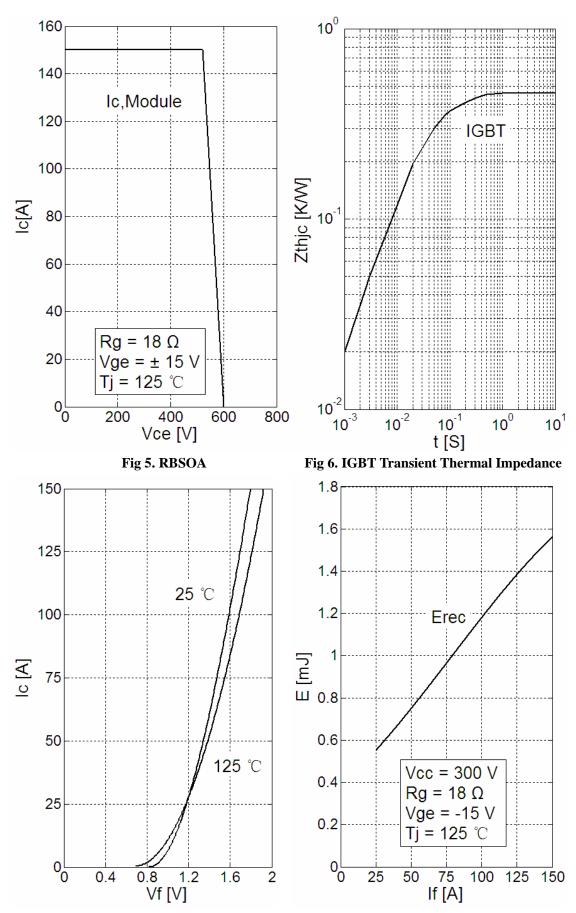


Fig 7. Diode Typical Forward Characteristics

Fig 8. Diode Switching Loss vs.  $I_{\rm F}\,$ 

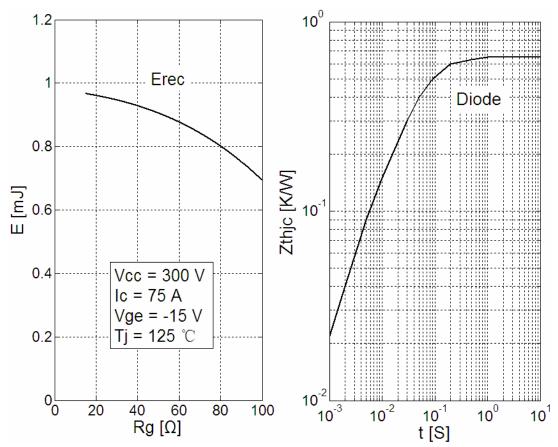
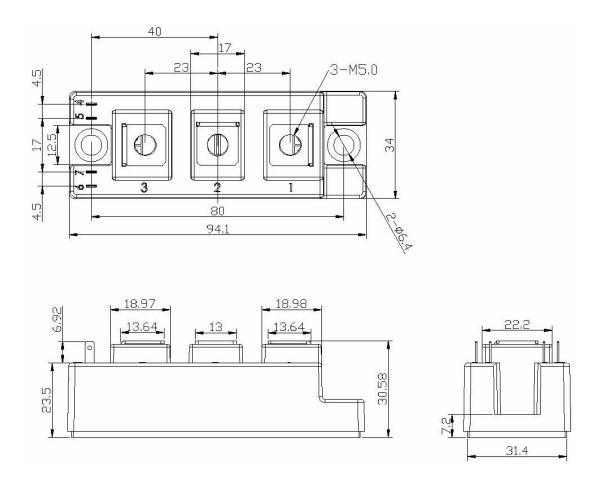


Fig 9. Diode Switching Loss vs.  $R_G$ 

Fig 10. Diode Transient Thermal Impedance

# **Package Dimension**

#### **Dimensions in Millimeters**



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